

LEOCO CORPORATION		PRODUCTION SPECIFICATION	No.	S-96-2010-7
<div>*2010 SERIES AND 2011 SERIES CONNECTOR*</div> <div>This product specification contains the test method, the general performance and requirements for interconnection systems connector with 2010 series socket, 2011 series header and 2033 series terminal.</div>				
<div>1. Construction and dimensions shall be in accordance with the referenced drawings. 产品结构和尺寸依据所提的产品图面</div> <div>2. Characteristics 特性: Current rating 额定电流: 2A DC Voltage rating 额定电压 : 125V AC Temperature rating 额定温度: -25℃ ~ +105℃ Applicable wire 适用的线: conductor construction size #24 ~ #30</div> <div>3. Electrical performance 电气特性:</div>				
ITEM 项目	DESCRIPTION 内容	TEST METHOD & CONDITION 测试方法及条件		REQUIREMENT 要求
3-1	Contact Resistance 接触阻抗	It should be tested in accordance with method EIA-364-23		Initial : 20 mΩ max. After environment -al tested: 40 mΩ max.
3-2	Insulation Resistance 绝缘电阻	It should be. tested in accordance with method EIA-364-21		Initial : 1000 MΩ min. After humidity tested: 500 MΩ min.
3-3	Dielectric withstanding Voltage 耐电压	Unmated connector shall be tested in accordance with method EIA-364-20 When the AC 500V rms for one minute applied between adjacent contacts.		No evidence of breakdown and flashover,
4. Mechanical Performance 机械特性 :				
ITEM 项目	DESCRIPTION 内容	TEST METHOD & CONDITION 测试方法及条件		REQUIREMENT 要求
4-1	Crimp tensile Strength 铆合张力强度	Pulling load shall be applied between correctly crimped contact and wire at a constant speed. Pulling speed : 25 mm / minute		AWG #24: 2.5kgf min. AWG #26: 1.5kgf min. AWG #28: 1.0kgf min. AWG #30: 0.8kgf min.
4-2	Contact insertion force 接触插入力	The force required to insert a contact into a housing Inserting speed: 25 mm / minute.		0.9 kgf max.
4-3	Contact removal force 接触拔出力	Crimped contact mounted in a housing shall be pulled in an alignment at a constant speed of 25 mm / minute.		1.0kgf min.
4-4	Post retention Force 保持力	The end of a post shall be pushed in a perpendicular to base housing at a constant speed of 25mm/minute.		1.0kgf min.

LEOCO CORPORATION		PRODUCTION SPECIFICATION	No.	S-96-2010-7
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4-5	Insertion force 插入力	Housing with contact mating header, at a constant speed of 25mm/minute.	0.65 kgf max.	
4-6	Withdrawal force 拔出力	Housing with contact mating header, Pull out from header at speed 25mm/minute.	0.1kgf min.	
4-7	Durability 耐久力	It should be tested in accordance with method EIA-364-09 Connector shall be subjected to 100 cycles Of insertion and withdrawal.	No defects. Contact resistance shall be 20 mΩ max.	
4-8	Vibration 振动性	The connector mated PCB shall be vibrated in accordance with method EIA-364-28 tested condition B. There shall be no current discontinuity longer than 1 microsecond during the test. Frequency:10-55-10 Hz/min. Amplitude: 1.52mm Period:2 hours for each direction.	No evidence of loosening of parts or electric discontinuity. Contact resistance less than twice of initial.	
5. Environmental Performance 环境特性:				
5-1	Humidity 耐湿性	The unmated connector shall be tested in accordance with method EIA-364-31 test procedure type I condition B. Temperature:40±2℃ Humidity:90-95% (RH), Period:96 hours	No damage. Contact resistance: Less than twice of Initial. Insulation resistance: 1vchghghdara .3-2. Dielectric withstanding voltage: to pass para 3-3.	
5-2	Salt Spray 盐雾测试	connector shall be tested in accordance with method EIA-364-26 Temperature:35±2℃ Density: 5% in weight. Period:48 hours	No damage Contact resistance: Less than twice of initial.	
5-3	Solder ability 着锡性	Connector termination ends shall be checked for solder ability in accordance with method EIA-364-52 Solder temperature:245±5℃ Immersion period:5±0.5sec.	No damage Minimum:95% of immersed area.	

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Item	Description	Test Method & Condition		Requirement
5-4	Resistance to soldering heat 耐高温焊接	Specimen shall be mounted on PCB. Solder temperature:255±5℃ Immersion period:5±0.5sec.		No damage and deformation.

6. 2010 Series and 2011 Series Mating force and unmating force:

Unit:Kgf

Number of Circuits	Mating Force	Unmating Force	Unmating Force
	Initial(max.)	Initial (min.)	50 <sup>th</sup> (min.)
2	2.50	0.80	0.60
3	3.00	0.80	0.60
4	3.50	1.00	0.80
5	4.00	1.00	0.80
6	4.50	1.20	1.00
7	5.00	1.20	1.00
8	5.50	1.40	1.20
9	6.00	1.40	1.20
10	6.50	1.60	1.40
11	7.00	1.60	1.40
12	7.50	1.80	1.60
13	8.00	2.00	1.80
14	8.00	2.00	1.80
15	8.00	2.00	1.80
16	9.50	2.60	2.20

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